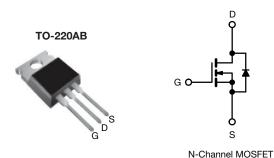
COMPLIANT

HALOGEN

FREE



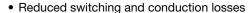
EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	6	50		
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.061			
Q _g max. (nC)	18	89		
Q _{gs} (nC)	26			
Q _{gd} (nC)	5	55		
Configuration	Sir	ngle		

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP38N60EF-GE3

ABSOLUTE MAXIMUM RATINGS	Γ _C = 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	600	V		
Gate-source voltage		V_{GS}	± 30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Continuous drain surrent (T = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	1	40		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	25	Α	
Pulsed drain current ^a I _{DM}		111				
Linear derating factor				2.5	W/°C	
Single pulse avalanche energy b		E _{AS}	508	mJ		
Maximum power dissipation		P _D	313	W		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	$T_J = 1$	T _J = 125 °C		100	1//	
Reverse diode dv/dt ^d			dv/dt	50	V/ns	
Soldering recommendations (peak temperature) ^c For 10 s			260	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 6.0 A
- c. 1.6 mm from case
- d. $I_{SD} = 23.5$ A, di/dt = 250 A/ μ s, starting $T_J = 25$ °C

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	40	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.4	G/ VV



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 10 mA		-	0.72	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2	-	4	V
Cata aguirea laglaga		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zoro goto voltago droin ourrent		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 23.5 A	-	0.061	0.070	Ω
Forward transconductance a	9fs	V _{DS} =	30 V, I _D = 23.5 A	-	13	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	3576	-	
Output capacitance	C _{oss}	,	$V_{DS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		167	-	pF
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	104	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	535	-	
Total gate charge	Qg			-	126	189	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 23.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	26	-	nC
Gate-drain charge	Q _{gd}			-	55	-	
Turn-on delay time	t _{d(on)}			=.	35	70	
Rise time	t _r	V _{DD} = 480 V, I _D = 23.5 A,		=	63	126	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		143	286	ns
Fall time	t _f	1		=.	67	134	
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	
Pulsed diode forward current	I _{SM}			ı	-	111	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 23.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	160	320	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 23.5 \text{A},$ $di/dt = 100 \text{A/µs}, V_R = 400 \text{V}$		_	1.2	2.4	μC
Reverse recovery current	I _{RRM}			-	14.3	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

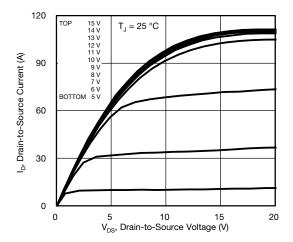


Fig. 1 - Typical Output Characteristics

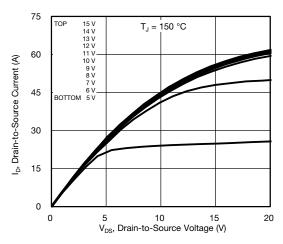


Fig. 2 - Typical Output Characteristics

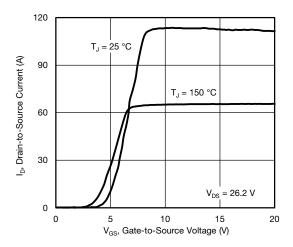


Fig. 3 - Typical Transfer Characteristics

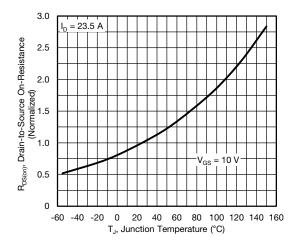


Fig. 4 - Normalized On-Resistance vs. Temperature

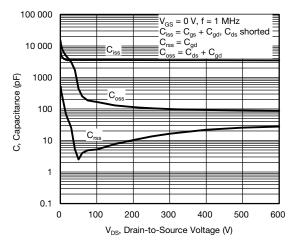


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

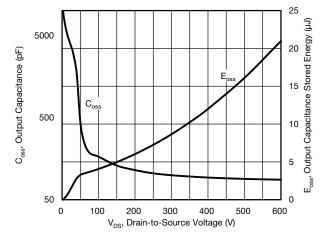


Fig. 6 - Coss and Eoss vs. VDS



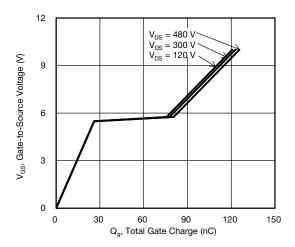


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

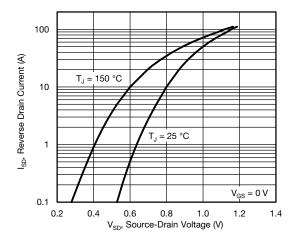


Fig. 8 - Typical Source-Drain Diode Forward Voltage

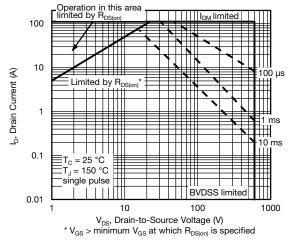


Fig. 9 - Maximum Safe Operating Area

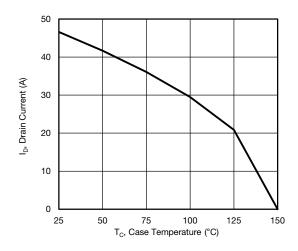


Fig. 10 - Maximum Drain Current vs. Case Temperature

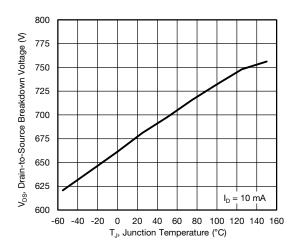


Fig. 11 - Temperature vs. Drain-to-Source Voltage



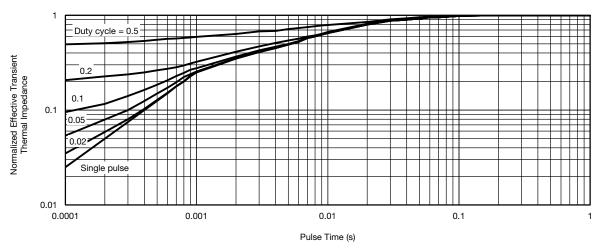


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

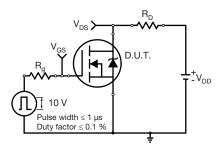


Fig. 13 - Switching Time Test Circuit

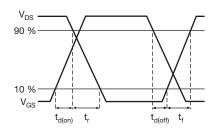


Fig. 14 - Switching Time Waveforms

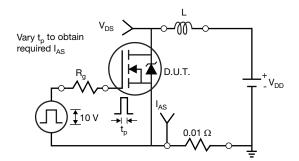


Fig. 15 - Unclamped Inductive Test Circuit

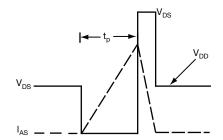


Fig. 16 - Unclamped Inductive Waveforms

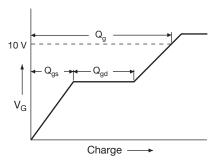


Fig. 17 - Basic Gate Charge Waveform

Current regulator Same type as D.U.T D.U.T. V_{GS} >

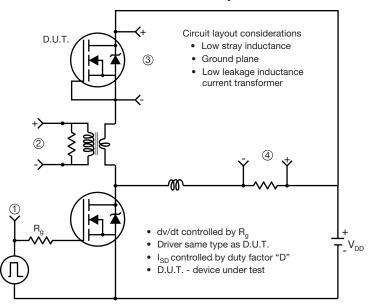
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Fig. 18 - Gate Charge Test Circuit

Current sampling resistors



Peak Diode Recovery dv/dt Test Circuit



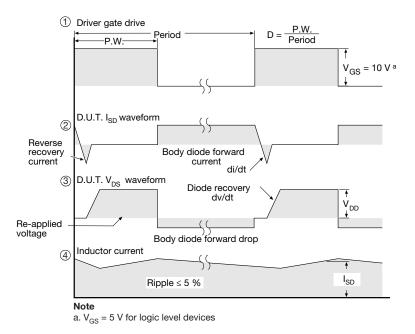
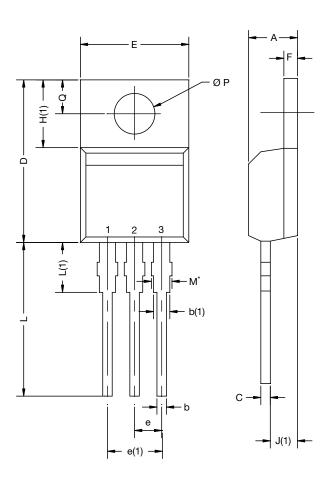


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIM	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

DWG: 6031

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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